

Service, Repair, and Return Policies and Instructions

The information contained in this document supersedes all similar information that may be found elsewhere in this manual.

Service - Due to the sophisticated nature of the sensors and associated instrumentation provided bγ Piezotronics, user servicing or repair is not recommended and, if attempted, may void the factory warranty. Routine maintenance, such as the cleaning of electrical connectors, housings, and mounting surfaces with solutions and techniques that will not harm the physical material of construction, is acceptable. Caution should be observed to ensure that liquids are not permitted to migrate into devices that are not hermetically sealed. Such devices should only be wiped with a dampened cloth and never submerged or have liquids poured upon them.

Repair – In the event that equipment becomes damaged or ceases to operate, arrangements should be made to return the equipment to PCB Piezotronics for repair. User servicing or repair is not recommended and, if attempted, may void the factory warranty.

Calibration – Routine calibration of sensors and associated instrumentation is recommended as this helps build confidence in measurement accuracy and acquired data. Equipment calibration cycles typically are established by the users own quality regimen. When in doubt about a calibration cycle, a good "rule of thumb" is to recalibrate on an annual basis. It is

also good practice to recalibrate after exposure to any severe temperature extreme, shock, load, or other environmental influence, or prior to any critical test.

PCB Piezotronics maintains an ISO-9001 certified metrology laboratory and offers calibration services, which are accredited by A2LA to ISO/IEC 17025, with full traceability to SI through N.I.S.T. In addition to the normally supplied calibration, special testing is also available, such as: sensitivity at elevated or cryogenic temperatures, phase response, extended high or low frequency response, extended range, testing, hydrostatic leak pressure testing, and others. For information on standard recalibration services special testing, contact your local PCB Piezotronics distributor. sales or factory representative. customer service representative.

Returning **Equipment** – Following these procedures will ensure that your returned materials are handled in the expedient Before most manner. returnina any equipment to PCB Piezotronics, contact your local distributor, sales representative, or factory customer service representative to obtain a Return Warranty, Service, Repair, and Return Policies and Instructions Materials Authorization (RMA) Number. This RMA number should be clearly marked on the outside of all package(s) and on the packing

list(s) accompanying the shipment. A detailed account of the nature of the problem(s) being experienced with the equipment should also be included inside the package(s) containing any returned materials.

A Purchase Order, included with the returned materials, will expedite the turn-around of serviced equipment. It is recommended to include authorization on the Purchase Order for PCB to proceed with any repairs, as long as they do not exceed 50% of the replacement cost of the returned item(s). PCB will provide a price quotation or replacement recommendation for any item whose repair costs would exceed 50% of replacement cost, or any item that is not economically feasible to repair. For routine calibration services. the Order Purchase should include authorization to proceed and return at current pricing, which can be obtained a factory customer service representative.

Contact Information – International customers should direct all inquiries to their local distributor or sales office. A

complete list of distributors and offices found at www.pcb.com. be Customers within the United States may contact their local sales representative or factory customer а representative. A complete list of sales representatives can be found at www.pcb.com. Toll-free telephone numbers for a factory customer service representative. in the division responsible for this product, can be found on the title page at the front of this manual. Our ship to address and general contact numbers are:

PCB Piezotronics, Inc. 3425 Walden Ave. Depew, NY14043 USA Toll-free: (800) 828-8840 24-hour SensorLineSM: (716) 684-0001

Website: www.pcb.com E-mail: info@pcb.com



PCB工业监视和测量设备 - 中国RoHS2公布表

PCB Industrial Monitoring and Measuring Equipment - China RoHS 2 Disclosure Table

	有害物 质					
部件名称	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
住房	0	0	0	0	0	0
PCB板	Х	0	0	0	0	0
电气连接器	0	0	0	0	0	0
压电晶 体	Х	0	0	0	0	0
环氧	0	0	0	0	0	0
铁氟龙	0	0	0	0	0	0
电子	0	0	0	0	0	0
厚膜基板	0	0	Х	0	0	0
电线	0	0	0	0	0	0
电缆	Х	0	0	0	0	0
塑料	0	0	0	0	0	0
焊接	Х	0	0	0	0	0
铜合金/黄铜	Х	0	0	0	0	0

本表格依据 SJ/T 11364 的规定编制。

CHINA RoHS COMPLIANCE

O:表示该有害物质在该部件所有均质材料中的含量均在 GB/T 26572 规定的限量要求以下。

X:表示该有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 规定的限量要求。铅是欧洲RoHS指令2011/65/ EU附件三和附件四目前由于允许的豁免。

Component Name	ame Hazardous Substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Chromium VI Compounds (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)
Housing	0	0	0	0	0	0
PCB Board	Х	0	0	0	0	0
Electrical Connectors	0	0	0	0	0	0
Piezoelectric Crystals	Х	0	0	0	0	0
Ероху	0	0	0	0	0	0
Teflon	0	0	0	0	0	0
Electronics	0	0	0	0	0	0
Thick Film Substrate	0	0	Х	0	0	0
Wires	0	0	0	0	0	0
Cables	Х	0	0	0	0	0
Plastic	0	0	0	0	0	0
Solder	Х	0	0	0	0	0
Copper Alloy/Brass	Х	0	0	0	0	0

This table is prepared in accordance with the provisions of SJ/T 11364.

DOCUMENT NUMBER: 21354
DOCUMENT REVISION: D

ECN: 46162

O: Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572.

X: Indicates that said hazardous substance contained in at least one of the homogeneous materials for this part is above the limit requirement of GB/T 26572.

Lead is present due to allowed exemption in Annex III or Annex IV of the European RoHS Directive 2011/65/EU.



Installation and Operating Manual ICP® Impulse Force Test Hammer

Contents:

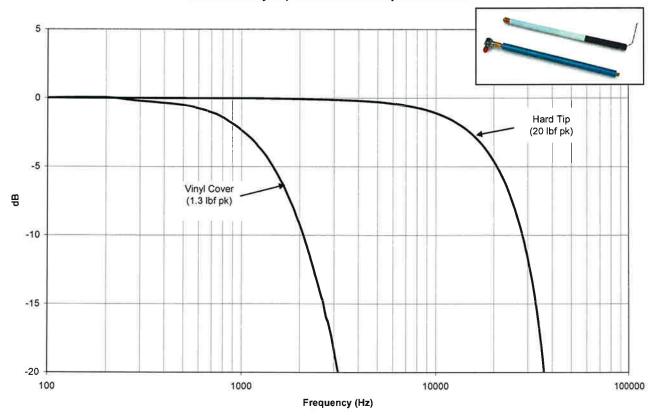
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1.0 INTRODUCTION

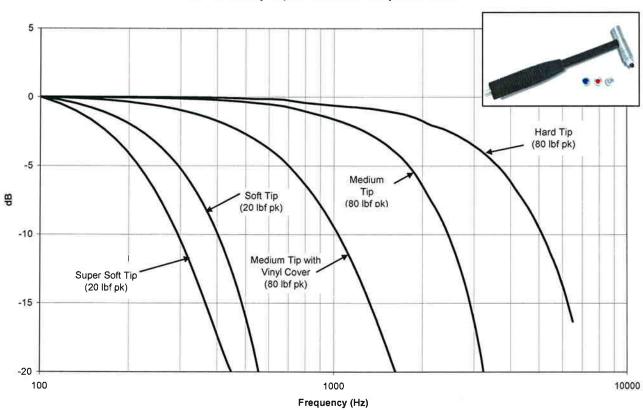
The ICP® Impulse Force Test Hammer adapts your FFT analyzer for structural behavior testing. Impulse testing of the dynamic behavior of mechanical structures involves striking the test object with the force-instrumented hammer, and measuring either the resultant motion with an accelerometer or the acoustic signature with a microphone. Structures generally respond as (1) rigid or elastic bodies, (2) finite elements, lumped constant models, and (3) distributed parameter models conducting stress-strain (sound) waves.

Testing the functional transfer and transactional characteristics of a mechanical structure involves mounting the accelerometer at one location of interest, and striking the test object with the hammer. Modal analysis and modeling involves fixing the accelerometer(s) at one location, impacting the structure at one point, and then moving the accelerometer(s) to other points of interest. Integration of the acceleration signal yields velocity compliance, impedance, and mobility. The hammer impulse consists of a nearly-constant force over a broad frequency range, and is therefore capable of exciting all resonances in that range. The hammer, size, length, material, and velocity at impact determine the amplitude and frequency content (wave shape) of the force impulse. The impact cap material generally determines energy content. The force spectrums of an impact on a stiff steel mass for hammers with their available tips are shown below.

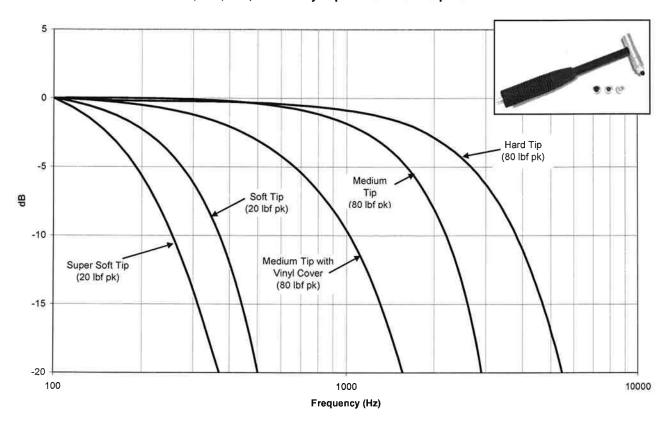
086E80 Family Impulse Hammer Response Curves



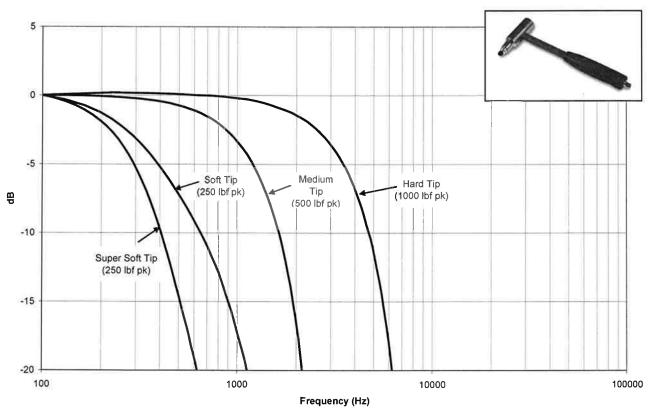
086C01 Family Impulse Hammer Response Curve



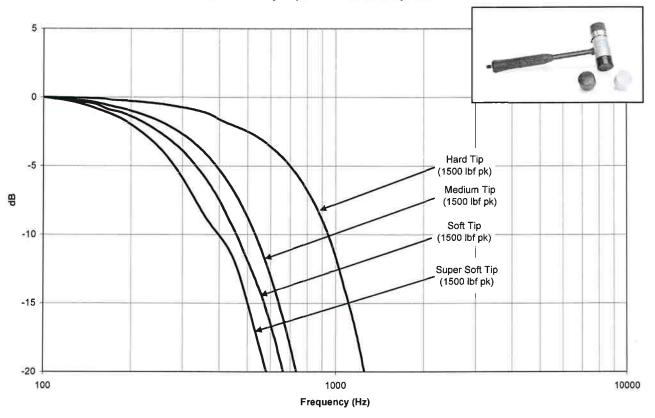
086C02, C03, C04, C40 Family Impulse Hammer Response Curves



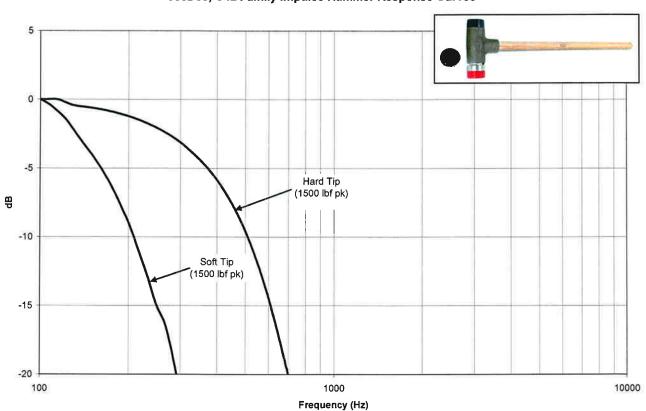
086D05 Family Impulse Hammer Response Curves



086D20, C41 Family Impulse Hammer Response Curves



086D50, C42 Family Impulse Hammer Response Curves



PCB[®] impulse hammers are available in sizes ranging from the mini-impulse hammer to the 12 lb sledgehammer. All sensors in this system are classified as ICP[®] (Integrated Circuit Piezoelectric), low impedance, voltage-mode sensors. Microelectronic, built-in amplifiers standardize sensitivities within a few percent of nominal value, which is adequate for most dynamic applications.

Hammer model selection involves determining the size and mass of the hammer structure which will provide the force amplitude and frequency content required for proper excitation of the structure under test. Large, heavy structures like locomotive frames, tanks, and bridges require an instrumented sledgehammer; small structures like compressor blades often require mini-hammers. Some very large structures may require a massive mechanical ram instrumented with a force-sensing impact head.

2.0 DESCRIPTION

The hammer consists of an integral, ICP® quartz force sensor mounted on the striking end of the hammer head. The sensing element functions to transfer impact force into electrical signal for display and analysis. It is structured with rigid quartz crystals and a built-in, micro-electronic, unity gain amplifier. The cable is connected to the end of the handle for convenience, and to avoid connector damage in the event of a "miss hit."

The ICP® sensor operates over a standard two-wire cable from a PCB® power unit. For reasons of safety, the easily-repairable ribbon wire cable is intended to be the weak link in larger hammer design. The ICP® signal conditioner supplies constant current excitation to the sensor over the signal lead and AC couples the output signal. Many FFT analyzers and data acquisition systems have ICP® power supply built in.

The hammer is a single, integral unit. Laser-welded construction of the sensor element insures reliable operation in adverse environments. The mechanical assembly is locked together with a structural epoxy adhesive so it should not be taken apart except at the factory.

The striking end of the hammer has a threaded hole for installation of a variety of impact tips. The tip functions to transfer the force of impact to the sensor, and protects the sensor face from damage. Tips of different stiffness allow you to vary the pulse width and frequency content of the force. The specific frequency range can be found in the datasheet supplied with hammer. An extender mass, supplied with most hammers, allows further tuning by concentrating more energy at lower frequencies.

3.0 INSTALLATION AND OPERATION

The hammer is assembled and locked together with structural adhesive at the factory. Tips and extender mass install at opposite ends of the hammer via 10-32 threaded studs. In the case of the model 086E80 mini impulse hammer, the handle is removable.

- 1. With cables supplied, connect the hammer to an ICP® signal conditioner, and then to your analyzer, as shown in the system and power unit operation guide.
- 2. Tighten the cable connectors securely by hand to insure good electrical contact.
- 3. Switch power on, and wait a minute or two for the sensor amplifier to turn on, and for the coupling capacitor to fully charge. Check the power unit meter for normal operation (meter pointer pointing in green area).

- 4. If meter points in the red area, look for shorted cables or connections. If meter points points in the yellow area, look for open cables or connections.
- 5. Connect accelerometer(s) in similar manner referring to the appropriate operating guides for the accelerometer(s) and power unit. When all power unit meters indicate normal operation (green), proceed with tests, following all sensor, power unit, and analyzer operating instructions.

4.0 TESTING

Generally speaking, the impact tips affect the hammer impulse frequency content, and the extender affects the signal energy level. Frequency content and energy level are interrelated, so both will be affected by different hammer structures. Hammer velocity at impact will also affect both. In general, massive structures with lower stiffness require the use of the extender and soft impact tip to adequately excite low frequency resonances.

The frequency range of the hammer can be varied by changing the type of tip used. The following guidelines can be used to determine the ideal hammer configuration for a particular test setup:

- 1. For a higher frequency response, use a stiffer tip without the extender mass.
- 2. For a lower frequency response, use a softer tip and install the extender mass.
- 3. To increase motion signal energy, increase the impact velocity and/or hammer mass.

When using the model 086E80 mini impact hammer, the model 084A17 handle is designed for use in frequency ranges lower than those reached when using the model 084A14 handle. When using the model 084A17 handle, best results are achieved by mounting the model 084A13 extender mass to the back of the hammer as shown on the outline drawing. This will improve the low frequency content of the force input to the structure, as well as improve the "feel" of the hammer by offsetting any effective mass added to the handle base by an attached cable.

To test the behavior of your structure, and to tailor the frequency bandwidth of the force, follow the following procedure:

- 1. Strike the test object with the hammer and process the results. Always take several averages to reduce the effects of spurious noise.
 - **CAUTION:** Never impact without a hammer tip properly installed on the sensor element. In the case of the model 086E80 mini impact hammer, the sensor element is pre-installed with a steel tip.
- 2. Check the measured results for signal quality (adequate signal-to-noise), no overloads (overload lights or sharp flattening of time history peaks), and no double impacts.
- 3. Analyze results for frequency content, and check to insure that the reasonably flat portion of the force spectrum is sufficient to cover the structural resonances present in the acceleration spectrum. Often signal energy is sufficient to excite structural resonances at 20 dB below initial low frequency force levels.

During testing, occasionally check and tighten the electrical and mechanical connections. Repeated impacting tends to loosen them, which may result in erratic and noisy signals.

Although modal tuning has done much to eliminate this possibility, bouncing (multiple impacts) or penetration may still occur when using too heavy a hammer on too light a structure, or section of a

structure. This will appear as an oscillatory component superimposed on the spectrum in your data. Reject such data. Some skill and practice may still be required when testing lighter structures.

PCB's newest ICP® power units providing greater than 10 volts positive signal range (three x 9 volt batteries) prevent undetected overloads in the power unit. Distortion, undershoot, and oscillation of the impulse time history as viewed on the analyzer display is caused by ringing of the analyzer's antialiasing filters, which is their normal behavior. To view the correct impulse waveform, switch the analyzer to a high-frequency range.

When configuring your oscilloscope or data acquisition system, it is recommended that the input be set to DC coupled. This is because, in some cases, the time constant associated with the equipment's AC coupling circuit is less then that of the impulse hammer and PCB ICP® power units. This will cause a small offset in the output voltage of the hammer after impact, which will appear as a negative dip in the response on the down slope of the response with a gradual rise back to zero over a period of time.

5.0 CALIBRATION

Calibration involves testing the functional transfer behavior (sensitivity) of the sensor structure in controlled transactions and environments.

Different hammer structures have different sensitivities, because the test structure experiences a force greater than the crystal-sensing elements. The force of impact on the test structure is a function of the total mass of the hammer, while the force on the crystals is a function of only the mass behind them (the impact tip is in front of the crystal-sensing element). Their differences, which depend on the ratio of the tip mass to the head mass, is automatically compensated for when the hammer is properly calibrated, since the extender mass is behind the sensing element. When used, it results in a slight increase in voltage sensitivity (as shown on calibration certificate). Each hammer structure can be easily calibrated to ensure the most accurate data.

A hammer can be calibrated by hitting a freely-suspended mass instrumented with a reference accelerometer. According to Newton's second law of motion, at any instant in time, the force experienced by the mass is simply the mass multiplied by the measured acceleration. On a storage oscilloscope, dividing the peak output signal of the hammer (mV) by the mass (lb or kg), times the peak acceleration (g), gives the hammer sensitivity directly in mV/lb or mV/kg.

Calibration on a FFT analyzer produces the same result as a function of frequency. Since the transfer function of a mass behaving as a rigid body is a consistent (1/M) ratio, the force and the acceleration signals produces a calibration constant (ideally 1/M) for each discrete frequency. The effects of a non-modally tuned hammer will be readily apparent when performing this calibration.

The mass, pendulously suspended or placed on a piece of foam rubber, will behave as a rigid body. Hitting such an instrumented mass is also a good way of checking the normal operation of the hammer and instruments prior to testing. This procedure builds confidence in data results.

6.0 MAINTENANCE

The sealed construction of the sensing element and the bonded construction of the hammer preclude field maintenance. Should service be required, first replace the cables (cables are often the source of

trouble) and test operation again. If necessary, return the unit to the factory with a note describing the problem.

7.0 PRECAUTIONS

Although hammers are very rugged in construction, damage can result from misuse. When observed, the following precautions can ensure long life and accurate data.

- 1. Do not attempt to dismantle sensor element from hammer structure. All service should be performed at the factory.
- 2. Never generate more than 5 times the rated impact force range with any hammer. Generally, observe the force rating for five volts output. Excessive impact force may destroy the built-in miniature electronics.
- 3. Never strike an object without an impact tip properly installed in front of the force-sensing element. Damaging the precision-lapped surface of the hammer sensor can affect its behavior.
- 4. During testing, periodically check and tighten tip, extender and cable connections to ensure continued proper operation. Machined flats in the tips and extender facilitate tightening and removal.
- 5. Do not apply voltage to unit without constant current protection.
- 6. Do not apply more than 20 mA of current.
- 7. Do not exceed 30 volts supply voltage.
- 8. Do not subject units to temperatures above 250 degrees F (121 degrees C).

8.0 WARRANTY AND SERVICE

All equipment and repair services provided by PCB Piezotronics, Inc. are covered by a warranty against defective material and workmanship under a **Total Customer Satisfaction** policy. See the supplemental sheet, contained with this manual, for information on our service, repair and return policies, procedures and instructions. When unexpected problems arise, call our 24-Hour SensorLineSM to discuss your immediate dynamic instrumentation needs with a factory representative. PCB guarantees **Total Customer Satisfaction**. If, at any time, for any reason, you are not completely satisfied with any PCB product, PCB will repair, replace, or exchange it at no charge. You may also choose to have your purchase price refunded. Contact PCB for a complete statement of our warranty.

3425 Walden Avenue, Depew, NY 14043-2495

24-hour SensorLineSM: 716-684-0001

E-Mail: <u>vibration@pcb.com</u>
Website: <u>www.pcb.com</u>

Fax: 716-685-3886

Vibration Division toll-free: 888-684-0013

A PCB GROUP COMPANY

ISO 9001 CERTIFIED

A2LA ACCREDITED to ISO 17025

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Manual Number: 19198 Manual Revision: A

ECO 27899



VIB-086 Manual – 12/07 Printed in the U.S.A.

Model Number 086D50		ICP® IMPAC	T H	AMMER
Performance	ENGLISH	SI		
Sensitivity(± 15 %)	1 mV/lbf	0.23 mV/N		Optional version
Measurement Range	± 5000 lbf pk	± 22,240 N pk		
Resonant Frequency	≥ 5 kHz	≥ 5 kHz		
Non-Linearity	≤ 1 %	≤ 1 %		TLD - TEDS C
Electrical				Output Bias Vo
Excitation Voltage	20 to 30 VDC	20 to 30 VDC		
Constant Current Excitation	2 to 20 mA	2 to 20 mA		
Output Impedance	<100 Ohm	<100 Ohm	[1]	NOTES:
Output Bias Voltage	8 to 14 VDC	8 to 14 VDC		[1] Typical.
Discharge Time Constant	≥ 2000 sec	≥ 2000 sec	[1]	[2] See PCB De
Physical				[2] 0001 02 20
Sensing Element	Quartz	Quartz		
Sealing	Hermetic	Hermetic		
Hammer Mass	12.1 lb	5.5 kg		
Head Diameter	3.0 in	7.6 cm	SUPPLIED A Model 084A31 Model 084A32	
Tip Diameter	3.0 in	7.6 cm		
Hammer Length	35 in			Model HCS-2 C
Electrical Connection Position	Bottom of Handle	Bottom of Handle		
Electrical Connector	BNC Jack	BNC Jack		

OPTIONAL VERSIONS

Optional versions have identical specifications and accessories as listed for the standard model except where noted below. More than one option may be used.

TLD - TEDS Capable of Digital Memory and Communication Compliant with IEEE 1451.4 Output Bias Voltage 8.5 to 15 VDC 8.5 to 15 VDC

NOTES:

- [1] Typical.
- [2] See PCB Declaration of Conformance PS136 for details.

SUPPLIED ACCESSORIES:

Model 084A31 Tip - soft plastic, brown (1) Model 084A32 Tip - hard plastic, red (1)

Model HCS-2 Calibration of Series 086 instrumented impact hammers (1)

Entered: LK Engineer: BAM Sales: WDC Approved: BAM Spec Number:

12993 Date: 10/11/2016 Date: 10/11/2016 Date: 10/11/2016 Date: 10/11/2016



Phone: 716-684-0001 Fax: 716-684-0987 E-Mail: info@pcb.com

Revision: H

ECN #: 46036



All specifications are at room temperature unless otherwise specified.

In the interest of constant product improvement, we reserve the right to change specifications without notice.

ICP® is a registered trademark of PCB Group, Inc.

